

60/40 Halide Free Flux

Solder Wire



Features:

- Halide free version-Multicomp 400.
- Fast soldering-range of activities to suit all applications
- Good spread on copper, brass and nickel.
- Clear residues.
- Heat stable-low spitting.

Product Range:

Multicomp 400 is designed for users who require a halide free formulation. The remaining products in the range contain higher halide levels to maximise soldering power.

Multicomp 400, 502, 505 and 511 cored wires are manufactured with a range of flux contents. Although users will normally be using products with a nominal flux content of 3%, the superior performance of these products may allow a lower flux content to be specified e.g 2.2%. This will further improve residue appearance by reducing the quantity.

For applications requiring low residue halide free fluxes, Multicomp 400 is available at 1% flux content (formerly Multicomp X-39). Multicomp 400, 502, 505 and 511 cored wires are available in a variety of alloys conforming to J-STD-006 and EN 29453 or alloys conforming to similar national or international standards.

Technical Specification:

Alloys:

The alloys used for Multicomp cored solder wires conform to the purity requirements of the common national and international standards. A wide range of wire diameters is available manufactured to close dimensional tolerances.

Flux:

Multicomp 400, 502, 505 and 511 solid fluxes are based on modified rosins and carefully selected activators. In use they exhibit a mild rosin odour and leave a small quantity of clear residue.

Flux Properties				
Test	400	502	505	511
Acid value, mg/KOH/g	205 - 220	156 - 172	159 - 177	164 - 176
Halide content, %	0	0.2	0.5	1.1
J-STD-004 solder spread mm ² corrosion test	210 Pass	310 Pass	315 Pass	340 Pass
SIR test (without cleaning) IPC-SF-818 Class3 Bellcore TR-NWT-000078	Pass Pass	Pass Pass	Pass Pass	Pass Pass
Electromigration-test (without cleaning) Bellcore TR-NWT-000078	Pass	Pass	Pass	Pass
Classification EN 29454-1 J-STD-004 IPC-SF-818	1.1.3 ROLO LR3CN	1.1.2 ROM1 MR3CN	1.2.2 ROM1 MR3CN	1.1.2 ROM1 MR3CN



60/40 Halide Free Flux

Solder Wire



Special Properties:

Multicomp 400, 502, 505 and 511 cored solder wires are designed to give fast and sustained wetting on both copper and brass. This can be demonstrated using spreading tests on both substrates under standard conditions for the Multicomp products and comparable competitor products. After 5 seconds, area of spread is measured to form a comparative index indicating total flux efficacy.

Relative Wetting Performance of Multicomp and Halide Free Competitor Products*			
Product	Flux Content (%)	Area of Spread (mm ²)	
		Oxidised Copper*	Oxidised Brass
Multicomp 400	2.2	222	209
Competitor A	3.5	191	140
Competitor B	2.5	202	

*Oxidised for 1 hour at 205°C.

Relative Wetting Performance of Multicomp and Competitor Products*				
Product	Flux Content (%)	Halide Content (%)	Area of Spread (mm ²)	
			Oxidised Copper*	Oxidised Brass
Multicomp 502	2.7	0.2	220	160
Competitor E	2.0	0.4	200	150
Competitor F	2.4		190	180
Competitor G	3.5		150	120
Competitor H	2.7	0.5	230	150
Multicomp 505			220	240

*Oxidised for 1 hour at 205°C.

Recommended Operating Conditions:

Soldering Iron:

Good results should be obtained using a range of tip temperatures. However, the optimum tip temperature and heat capacity required for a hand soldering process is a function of both soldering iron design and the nature of the task and care should be exercised to avoid unnecessarily high tip temperatures for excessive times. A high tip temperature will increase any tendency to flux spitting and it may produce some residue darkening.

The soldering iron tip should be properly tinned and this may be achieved using Multicomp cored wire. Severely contaminated soldering iron tips should first be cleaned and pre-tinned using Multicomp Tip Tinner/Cleaner TTC1, then wiped on a clean, damp sponge before re-tinning with Multicomp cored wire.

Soldering process:

Multicomp cored wires contain a careful balance of resins and activators to provide clear residues, maximum activity and high residue reliability, without cleaning in most situations. To achieve the best results from Multicomp solder wires, recommended working practices for hand soldering should be observed as follows:

- Apply the soldering iron tip to the work surface, ensuring that it simultaneously contacts the base material and the component termination to heat both surfaces adequately. This process should only take a fraction of a second.
- Apply Multicomp flux cored solder wire to a part of the joint surface away from the soldering iron and allow to flow sufficiently to form a sound joint fillet-this should be virtually instantaneous. Do not apply excessive solder or heat to the joint as this may result in dull, gritty fillets and excessive or darkened flux residues.
- Remove solder wire from the work piece and then remove the iron tip.



60/40 Halide Free Flux

Solder Wire



The total process will be very rapid, depending upon thermal mass, tip temperature and configuration and the solderability of the surfaces to be joined.

Multicomp flux cored solder wires provide fast soldering on copper and brass surfaces as well as solder coated materials. Activity of the halide activated versions on nickel is also good depending on the state of oxidation of the nickel finish. The good thermal stability of Multicomp fluxes means they are also well suited to soldering applications requiring high melting temperature alloys.

Cleaning:

Multicomp 400, 502, 505 and 511 flux cored solder wires have been formulated to leave pale flux residues and to resist spilling and fuming.

Cleaning will not be required in most situations but if necessary this is best achieved using Multicomp MCF800 Cleaner. Other proprietary solvent or semi-aqueous processes may be suitable. Saponification may be viable but customers must ensure that the desired level of cleanliness can be achieved by their chosen system.

Healthy and Safety:

Warning:

The following information is for guidance only and users must refer to the Material Safety Data Sheets relevant to specific Multicomp flux cored solder wires before use.

Health Hazards and Precautions:

Inhalation of the flux fumes given off during soldering should be avoided. The fumes are irritating to the throat and respiratory system. Prolonged or repeated exposure to rosin or modified rosin based flux fumes may lead to the development of respiratory sensitisation and occupational asthma.

Multicomp solder wires must always be used with suitable fume extraction equipment to remove fumes from the breathing zone of operators and the general work environment.

Solder alloys containing lead give off negligible fume at normal soldering temperatures up to 500°C.

Normal handling of lead alloy wires will not cause lead to be absorbed through the skin. The most likely route of entry is through ingestion but this will not be significant if a good standard of personal hygiene is maintained. Eating, drinking and smoking should not be permitted in the working area. Hands should be washed with soap and warm water after handling solder wire.

Waste disposal:

Wherever possible, waste solder wire should be recycled for recovery of metal. Otherwise it should be disposed of according to local or national regulations.

Part Number Table

Description	Part Number
Solder, 60/40 Halide-Free 0.5mm 250g	507-1136
Solder, 60/40 Halide-Free 0.7mm 250g	507-1148
Solder, 60/40 Halide-Free 0.9mm 250g	507-1150
Solder, 60/40 Halide-Free 1.2mm 250g	507-1161
Solder, 60/40 Halide-Free 0.7mm 500g	507-1185
Solder, 60/40 Halide-Free 0.9mm 500g	507-1197
Solder, 60/40 Halide-Free 1.2mm 500g	507-1203



60/40 Halide Free Flux Solder Wire



Notes:

International Sales Offices:

 AUSTRALIA – Farnell InOne Tel No: ++ 61 2 9645 8888 Fax No: ++ 61 2 9644 7898	 FINLAND – Farnell InOne Tel No: ++ 358 9 560 7780 Fax No: ++ 358 9 345 5411	 NETHERLANDS – Farnell InOne Tel No: ++ 31 30 241 7373 Fax No: ++ 31 30 241 7333	 SWITZERLAND – Farnell InOne Tel No: ++ 41 1 204 64 64 Fax No: ++ 41 1 204 64 54
 AUSTRIA – Farnell InOne Tel No: ++ 43 662 2180 680 Fax No: ++ 43 662 2180 670	 FRANCE – Farnell InOne Tel No: ++ 33 474 68 99 99 Fax No: ++ 33 474 68 99 90	 NEW ZEALAND – Farnell InOne Tel No: ++ 64 9 357 0646 Fax No: ++ 64 9 357 0656	 UK – Farnell InOne Tel No: ++ 44 8701 200 200 Fax No: ++ 44 8701 200 201
 BELGIUM – Farnell InOne Tel No: ++ 32 3 475 2810 Fax No: ++ 32 3 227 3648	 GERMANY – Farnell InOne Tel No: ++ 49 89 61 39 39 39 Fax No: ++ 49 89 613 59 01	 NORWAY – Farnell InOne Tel No: ++ 45 44 53 66 66 Fax No: ++ 45 44 53 66 02	 UK – BuckHickman InOne ++ 44 8450 510 150 ++ 44 8450 510 130
 BRAZIL – Farnell-Newark InOne Tel No: ++ 55 11 4066 9400 Fax No: ++ 55 11 4066 9410	 HONG KONG – Farnell-Newark InOne Tel No: ++ 852 2268 9888 Fax No: ++ 852 2268 9899	 PORTUGAL – Farnell InOne Tel No: ++ 34 93 475 8804 Fax No: ++ 34 93 474 5288	 UK – CPC ++ 44 8701 202 530 ++ 44 8701 202 531
 CHINA – Farnell-Newark InOne Tel No: ++86 10 6238 5152 Fax No: ++86 10 6238 5022	 IRELAND – Farnell InOne Tel No: ++ 353 1 830 9277 Fax No: ++ 353 1 830 9016	 SINGAPORE – Farnell-Newark InOne Tel No: ++ 65 6788 0200 Fax No: ++ 65 6788 0300	 EXPORT – Farnell InOne Tel No: ++ 44 8701 200 208 Fax No: ++ 44 8701 200 209
 DENMARK – Farnell InOne Tel No: ++ 45 44 53 66 44 Fax No: ++ 45 44 53 66 06	 ITALY – Farnell InOne Tel No: ++ 39 02 93 995 200 Fax No: ++ 39 02 93 995 300	 SPAIN – Farnell InOne Tel No: ++ 34 93 475 8805 Fax No: ++ 34 93 474 5107	
 ESTONIA – Farnell InOne Tel No: ++ 358 9 560 7780 Fax No: ++ 358 9 345 5411	 MALAYSIA – Farnell-Newark InOne Tel No: ++ 60 3 7873 8000 Fax No: ++ 60 3 7873 7000	 SWEDEN – Farnell InOne Tel No: ++ 46 8 730 50 00 Fax No: ++ 46 8 83 52 62	

For enquiries from all other markets

<http://www.farnellinone.com>
<http://www.buckhickmaninone.com>
<http://www.cpc.co.uk>

Disclaimer This data sheet and its contents (the "Information") belong to the Premier Farnell Group (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. © Premier Farnell plc 2004.

